



Customer Information Notification

202106025I : ATKL LGA 10X6 Reel Hub Change from 4" to 7" to Remove Hazardous Materials from Packaging

Note: This notice is NXP Company Proprietary.

Issue Date: Aug 01, 2021 **Effective date:** Aug 02, 2021

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Management summary

ATKL Reel Hub Change from 4" to 7" to Remove Hazardous Materials.

Change Category

<input type="checkbox"/> Wafer Fab Process	<input type="checkbox"/> Assembly Process	<input type="checkbox"/> Product Marking	<input type="checkbox"/> Test Process	<input type="checkbox"/> Design
<input type="checkbox"/> Wafer Fab Materials	<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Equipment	<input type="checkbox"/> Errata
<input type="checkbox"/> Wafer Fab Location	<input type="checkbox"/> Assembly Location	<input checked="" type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Location	<input type="checkbox"/> Electrical spec./Test coverage
<input type="checkbox"/> Firmware	<input type="checkbox"/> Other			

PCN Overview

Description

NXP is pleased to announce the 10X6 LGA module product change of Reel Hub from 4" to 7" to remove hazardous material (Pink Poly Ethylene foam ring). By making this change, all 10X6 LGA module reels can remove the pink PE foam ring without changing the trailer and leader.

The NXP-ATKL Reel Hub Packaging change will be applied to all available 10X6 LGA products, including:

A3M34TL039T2
A3M34TL139T2
A3M35TL039T2
A3M37TL039T2
A3M39TL039T2
AFSC5G23D34T2
AFSC5G23D37T2
AFSC5G23E37T2
AFSC5G26D37T2
AFSC5G26E38T2
AFSC5G26E39T2

AFSC5G26F38T2
AFSC5G35D35T2
AFSC5G35D37T2
AFSC5G35E37T2
AFSC5G35E38T2
AFSC5G37D37T2
AFSC5G37E38T2
AFSC5G40E38T2

Reason

Assembly site Packaging change to remove hazardous material from 10X6 LGA Reel.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Poly Ethylene pink foam ring will be removed as of August 30 2021

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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NXP Quality Management Team.

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Changed Orderable Part#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line
AFSC5G23D37T2	935373052528	AFSC5G23D37T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	RFS	No	BLRF
AFSC5G26D37T1	935345736537	AFSC5G26D37T1	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	DOD	No	BLRF
AFSC5G26E38T2	935390244528	AFSC5G26E38T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	RFS	No	BLRF
AFSC5G26F38T2	935401129528	AFSC5G26F38T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G26E39T2	935400723528	AFSC5G26E39T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G35D35T2	935363153528	AFSC5G35D35T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	RFS	No	BLRF
AFSC5G35D37T2	935369413528	AFSC5G35D37T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	RFS	No	BLRF
A3M34TL139T2	935426557528	A3M34TL139T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
A3M34TL039T2	935420319528	A3M34TL039T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
A3M35TL039T2	935404496528	A3M35TL039T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
A3M37TL039T2	935416055528	A3M37TL039T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
A3M39TL039T2	935419154528	A3M39TL039T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G35E37T2	935392267528	AFSC5G35E37T2	10x6 MODULE	H(L)LGA27SiP	SOT1831-2	ASM	No	BLRF
AFSC5G35E38T2	935408976528	AFSC5G35E38T2	10X6 MOLDULE	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G37E38T2	935415964528	AFSC5G37E38T2	10x6 Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G40E38T2	935409647528	AFSC5G40E38T2	10x6 Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G23E37T2	935426156528	AFSC5G23E37T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-2	RFS	No	BLRF
AFSC5G23D34T2	935376658528	AFSC5G23D34T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	WIT	No	BLRF
AFSC5G37D37T2	935377767528	AFSC5G37D37T2	10x6 SiP Module	H(L)LGA27SiP	SOT1831-1	RFS	No	BLRF